Dual $J\overline{K}$ flip-flop with set and reset; positive-edge trigger

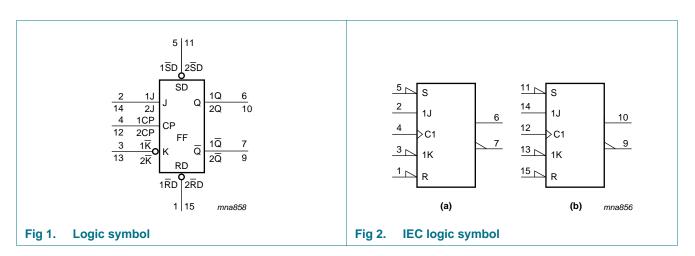
3. Ordering information

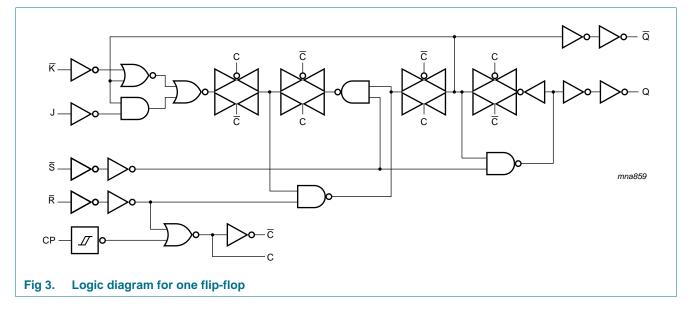
Table 1. Ordering information

All types are specified from -40 °C to +125 °C.

Type number	Package	Package						
	Name	Description	Version					
74LVC109D	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1					
74LVC109DB	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1					
74LVC109PW	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1					

4. Functional diagram



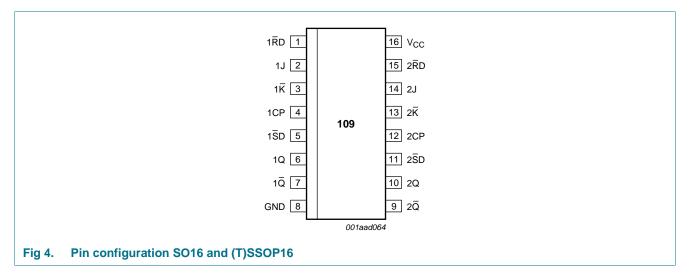


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Dual JK flip-flop with set and reset; positive-edge trigger

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
1RD	1	asynchronous reset input (active LOW)
1J	2	synchronous input
1 <mark>K</mark>	3	synchronous input
1CP	4	clock input (LOW-to-HIGH; edge-triggered)
1 <mark>S</mark> D	5	asynchronous set input (active LOW)
1Q	6	true flip-flop output
1 <mark>Q</mark>	7	complement flip-flop output
GND	8	ground (0 V)
2 <mark>Q</mark>	9	complement flip-flop output
2Q	10	true flip-flop output
2 <mark>S</mark> D	11	asynchronous set input (active LOW)
2CP	12	clock input (LOW-to-HIGH; edge-triggered)
2 <mark>K</mark>	13	synchronous input
2J	14	synchronous input
2RD	15	asynchronous reset input (active LOW)
V _{CC}	16	supply voltage

Dual JK flip-flop with set and reset; positive-edge trigger

6. Functional description

Table 3. Function selection^[1]

Operating modes	Input						Output	
	nSD	nRD	nCP	nJ	nK	nQ	nQ	
Asynchronous set	L	Н	Х	Х	Х	Н	L	
Asynchronous reset	Н	L	Х	Х	Х	L	Н	
Undetermined	L	L	Х	Х	Х	Н	Н	
Toggle	Н	Н	\uparrow	h	I	q	q	
Load 0 (reset)	Н	Н	\uparrow	I	I	L	Н	
Load 1 (set)	Н	Н	\uparrow	h	h	Н	L	
Hold no change	Н	Н	\uparrow	I	h	q	q	

[1] H = HIGH voltage level

h = HIGH voltage level one set-up time before the LOW-to-HIGH CP transition

L = LOW voltage level

I = LOW voltage level one set-up time before the LOW-to-HIGH CP transition

q = lower case letters indicate the state of the referenced output one set-up time before the LOW-to-HIGH CP transition

X = don't care

 \uparrow = LOW-to-HIGH CP transition

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		[1] -0.5	+6.5	V
I _{OK}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage		[2] -0.5	V _{CC} + 0.5	V
I _O	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	[3] _	500	mW
T _{stg}	storage temperature		-65	+150	°C

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO16 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. For (T)SSOP16 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.

Dual JK flip-flop with set and reset; positive-edge trigger

8. Recommended operating conditions

Table 5.	Recommended operating condition	ons				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
		V_{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	-40 °C to	o +125 ℃	Unit
			Min Typ ^[1] Max		Min	Max	-	
VIH	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{\text{CC}}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V_{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V _{он}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
output voltage		$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		I_{O} = -8 mA; V_{CC} = 2.3 V	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		I_{O} = 4 mA; V_{CC} = 1.65 V	-	-	0.45	-	0.65	V
		I_{O} = 8 mA; V_{CC} = 2.3 V	-	-	0.6	-	0.8	V
		I_0 = 12 mA; V_{CC} = 2.7 V	-	-	0.4	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	±0.1	±5	-	±20	μΑ

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Dual JK flip-flop with set and reset; positive-edge trigger

Symbol F	Parameter	arameter Conditions	-40	–40 °C to +85 °C			o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
I _{CC}	supply current	$V_{CC} = 3.6 \text{ V}; \text{ V}_{I} = V_{CC} \text{ or GND};$ $I_{O} = 0 \text{ A}$	-	0.1	10	-	40	μA
ΔI_{CC}	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_{I} = V_{CC} - 0.6 V; I_{O} = 0 A$	-	5	500	-	5000	μΑ
CI	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_I = GND \text{ to } V_{CC}$	-	5.0	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	o +125 ℃	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation	nCP to nQ, n \overline{Q} ; see Figure 5	[2]						
	delay	V _{CC} = 1.2 V		-	15	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		1.7	6.8	15.0	1.7	17.4	ns
		V_{CC} = 2.3 V to 2.7 V		2.7	3.9	8.1	2.7	9.4	ns
		$V_{CC} = 2.7 V$		1.5	3.9	7.3	1.5	9.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.5	6.8	1.0	8.5	ns
t _{PLH}	LOW to	$n\overline{S}D$, $n\overline{R}D$ to nQ , $n\overline{Q}$; see <u>Figure 6</u>							
	HIGH propagation	V _{CC} = 1.2 V		-	16	-	-	-	ns
	delay	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		1.0	6.2	15.6	1.0	18.0	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.6	8.3	1.5	9.7	ns
		$V_{CC} = 2.7 V$		1.5	4.5	8.2	1.5	10.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.3	7.0	1.0	9.0	ns
t _{PHL}	HIGH to	$n\overline{S}D$, $n\overline{R}D$ to nQ , $n\overline{Q}$; see <u>Figure 6</u>							
	LOW propagation	V _{CC} = 1.2 V		-	13	-	-	-	ns
	delay	V_{CC} = 1.65 V to 1.95 V		1.5	6.7	14.4	1.5	16.7	ns
	-	V_{CC} = 2.3 V to 2.7 V		2.0	3.8	7.7	2.0	9.0	ns
		$V_{CC} = 2.7 V$		1.5	4.1	7.1	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.5	6.5	1.0	8.5	ns

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Dual JK flip-flop with set and reset; positive-edge trigger

-40 °C to +125 °C Symbol Parameter Conditions -40 °C to +85 °C Unit Min Typ^[1] Max Min Max clock HIGH or LOW; see Figure 5 pulse width tw $V_{CC} = 1.65 \text{ V}$ to 1.95 V 5.0 _ 5.0 ns -- $V_{CC} = 2.3 \text{ V}$ to 2.7 V 4.0 4.0 ns -- $V_{CC} = 2.7 V$ _ 3.3 3.3 _ ns $V_{CC} = 3.0 \text{ V}$ to 3.6 V 3.3 2.0 3.3 -ns set or reset HIGH or LOW; see Figure 6 $V_{CC} = 1.65 \text{ V}$ to 1.95 V 5.0 5.0 _ _ ns $V_{CC} = 2.3 \text{ V}$ to 2.7 V 4.0 4.0 -_ ns $V_{CC} = 2.7 V$ 3.0 3.0 --ns $V_{CC} = 3.0 \text{ V}$ to 3.6 V 3.0 3.0 --ns nSD, nRD to nCP; see Figure 6 recovery t_{rec} time V_{CC} = 1.65 V to 1.95 V 5.5 -5.5 -ns $V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$ 4.0 4.0 _ -ns $V_{CC} = 2.7 V$ 3.2 3.2 --ns $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ 3.0 3.0 --ns nJ and $n\overline{K}$ to CP; see Figure 5 set-up time t_{su} $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ 5.0 5.0 -_ ns $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ 3.5 3.5 --ns $V_{CC} = 2.7 V$ 2.7 2.7 _ -ns $V_{CC} = 3.0 \text{ V}$ to 3.6 V 2.5 --2.5 ns nJ and nK to nCP; see Figure 5 hold time t_h $V_{CC} = 1.65 \text{ V}$ to 1.95 V 3.0 3.0 --ns $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ 2.5 2.5 --ns $V_{CC} = 2.7 V$ 2.2 2.2 --ns $V_{CC} = 3.0 \text{ V}$ to 3.6 V 2.0 2.0 --ns maximum see Figure 5 f_{max} frequency $V_{CC} = 1.65 \text{ V}$ to 1.95 V 100 80 MHz --- V_{CC} = 2.3 V to 2.7 V 125 _ -100 _ MHz $V_{CC} = 2.7 V$ 150 120 MHz --- $V_{CC} = 3.0 \text{ V}$ to 3.6 V MHz 150 330 120 -output skew V_{CC} = 3.0 V to 3.6 V [3] 1.0 1.5 --ns t_{sk(o)} time power $V_I = GND$ to V_{CC} [4] CPD dissipation V_{CC} = 1.65 V to 1.95 V pF 11.4 ---capacitance $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ pF -17.6 --- $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ 23.1 _ pF ---

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

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[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

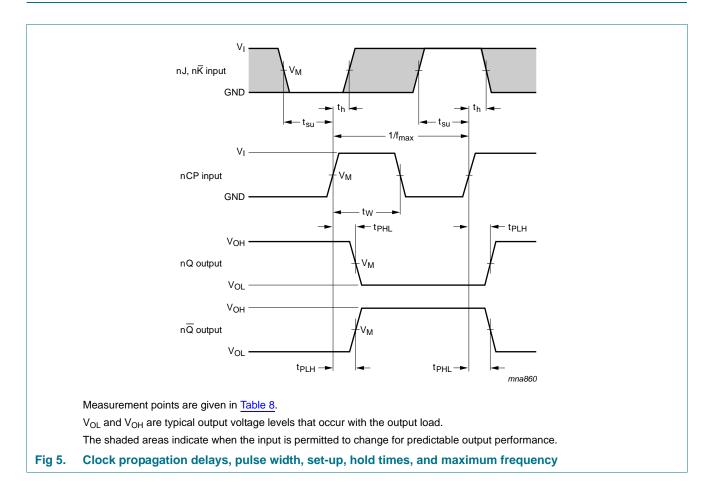
 C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of the outputs

11. AC waveforms



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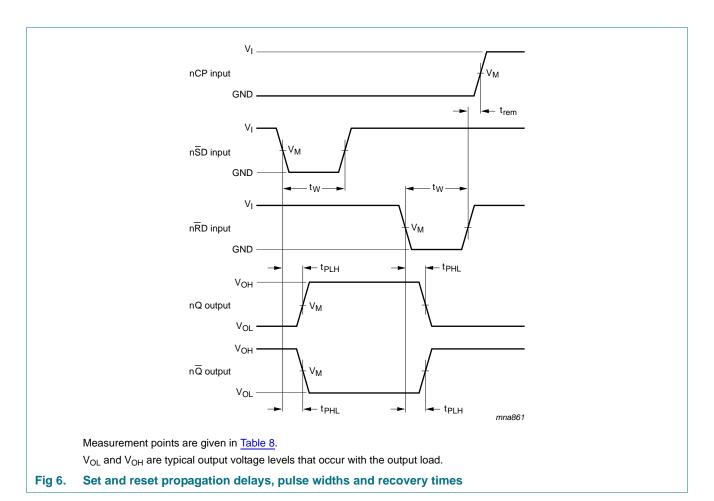


Table 8. Measurement points

Supply voltage	Input		Output	
V _{CC}	VI	V _M	V _M	
1.2 V	V _{CC}	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	
1.65 V to 1.95 V	V _{CC}	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	
2.3 V to 2.7 V	V _{CC}	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	
2.7 V	2.7 V	1.5 V	1.5 V	
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	

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Dual JK flip-flop with set and reset; positive-edge trigger

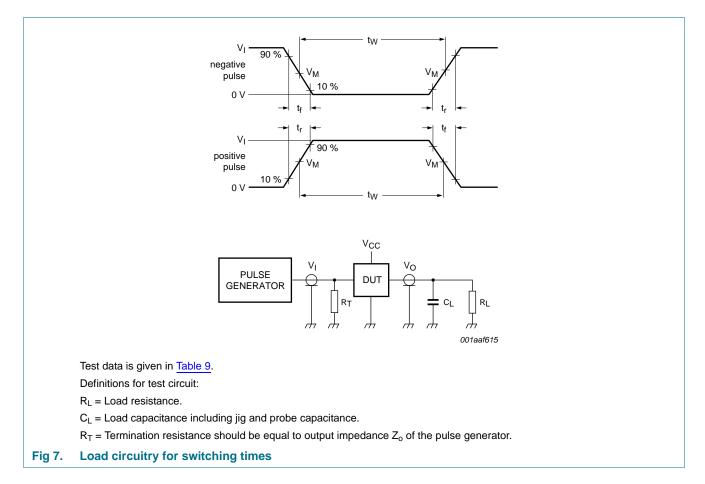


Table 9. Test data

Supply voltage	Input		Load		
	VI	t _r , t _f	CL	RL	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	

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Dual JK flip-flop with set and reset; positive-edge trigger

12. Package outline

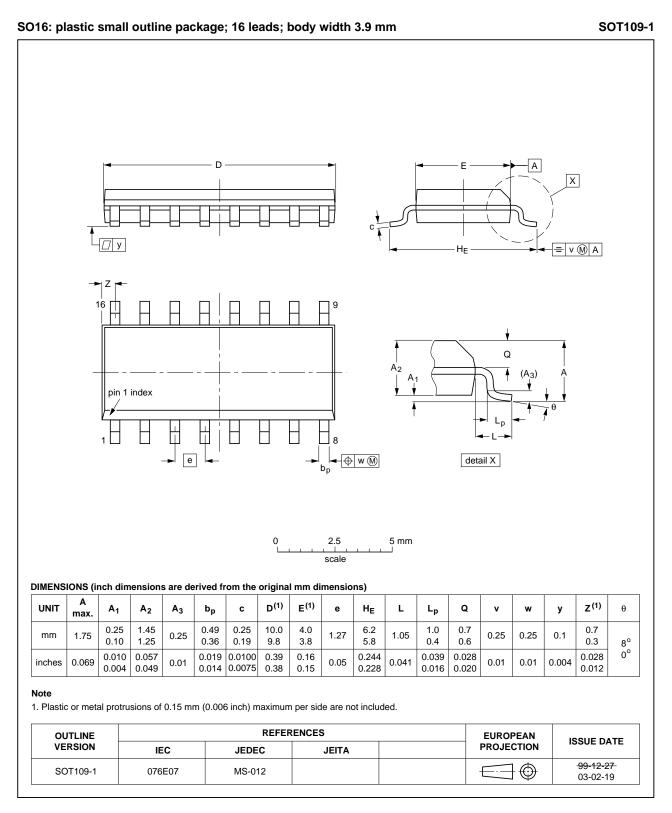


Fig 8. Package outline SOT109-1 (SO16)

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Dual JK flip-flop with set and reset; positive-edge trigger

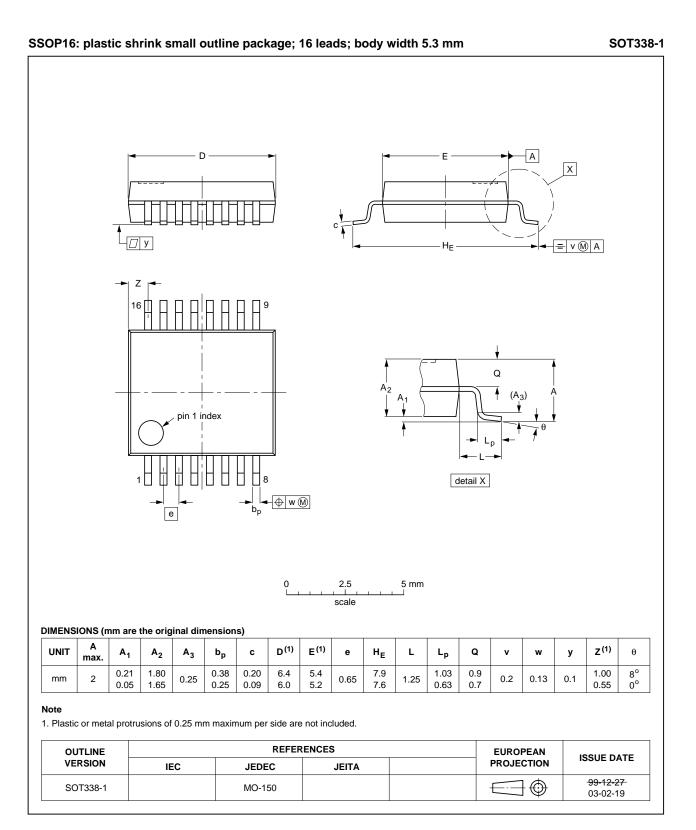


Fig 9. Package outline SOT338-1 (SSOP16)

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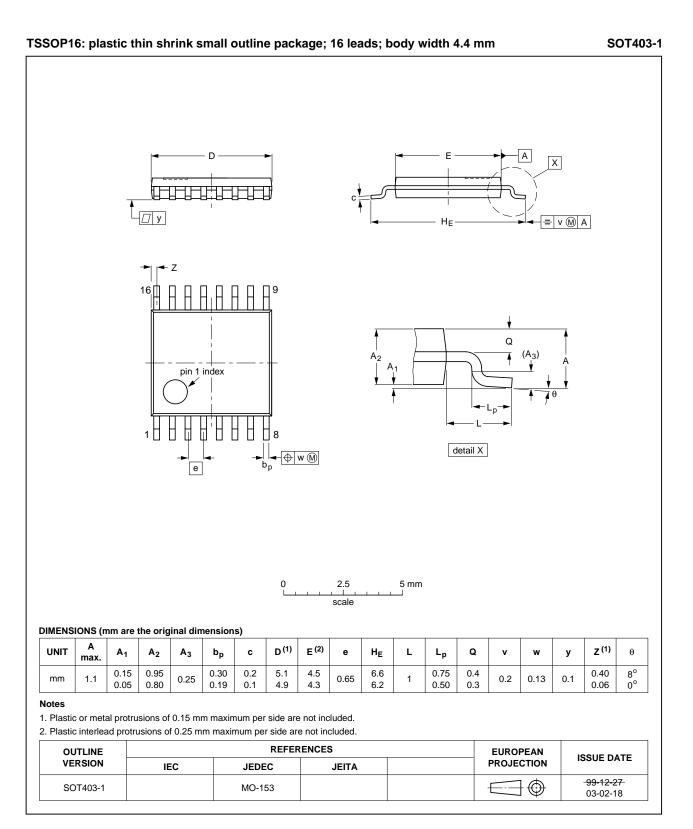


Fig 10. Package outline SOT403-1 (TSSOP16)

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Dual JK flip-flop with set and reset; positive-edge trigger

13. Abbreviations

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision h	istory						
Document ID	Release date	Data sheet status	Change notice	Supersedes			
74LVC109 v.5	20121129	Product data sheet	-	74LVC109 v.4			
Modifications:	Modifications: • The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.						
	 Legal texts have been adapted to the new company name where appropriate. 						
	• <u>Table 4, Table 5, Table 5</u> , <u>Table 5, <u>Table 5</u>, <u>Table 5</u>, <u>Table 5</u>, <u>Table 5, <u>Table 5</u>, <u>Table 5</u>, <u>Table 5, <u>Table 5</u>, <u>Table 5</u>, <u>Table 5, <u>T</u></u></u></u></u>	able 6, <u>Table 7</u> and <u>Table</u>	8: values added for lowe	r voltage ranges.			
74LVC109 v.4	20040318	Product specification	-	74LVC109 v.3			
74LVC109 v.3	19980428	Product specification	-	74LVC109 v.2			
74LVC109 v.2	19970318	Product specification	-	74LVC109 v.1			
74LVC109 v.1	-	-	-	-			

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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